MINMAX®

MRZI100 Series

Electric Characteristic Note

MRZI100 Series EC Note

DC-DC CONVERTER 100W, Reinforced Insulation, Railway Certified

Features

- ►**Industrial Standard Quarter Brick Package**
- ►**Ultra-wide Input Range 36-160VDC**
- ►**I/O Isolation 2000VAC with Reinforced Insulation**
- ►**Excellent Efficiency up to 91.5%**
- ►**Operating Baseplate Temp. Range -40℃ to +105℃**
- ►**No Min. Load Requirement**
- ►**Under-voltage, Overload/Voltage/Temp. and Short Circuit Protection**
- ►**Remote On/Off Control, Output Voltage Trim, Output Sense**
- ►**Vibration and Shock/Bump Test EN 61373 Approved**
- ►**Cooling, Dry & Damp Heat Test IEC/EN 60068-2-1, 2, 30 Approved**
- ►**Railway EMC Standard EN 50121-3-2 Approved**
- ►**Railway Certified EN 50155 (IEC60571) Approved**
- ►**Fire Protection Test EN 45545-2 Approved**
- ►**UL/cUL/IEC/EN 62368-1 Safety Approval & CE Marking**

Applications

- ►Distributed power architectures
- ►Workstations
- ►Computer equipment
- ►Communications equipment

Product Overview

The MINMAX MRZI100 series is a new generation of high performance 100W DC-DC converters in quarter brick package designed specifically for railway applications with popular 36-160 VDC input ranges. MRZI100 is approved by railway industry standard EN 50155 and complies with EMC standard EN 50121-3-2.
Advanced circuit topology provides a very high efficiency up to 91.5% which allows baseplate temperature up to 105℃ and very high I/O isolation up to 2000VAC with reinforced insulation which are designed to meet stringent requirements and harsh environment.
Further product features include under-voltage, overload/voltage/temp., short circuit protection, remote On/Off Control(positive/negative logic), output voltage trim, output sense and complies specifically fire protection test meets EN45545-2 to ensure safety during railway/railroad vehicle operation.

Table of contents

Model Selection Guide

Model Number	Input Voltage (Range) (9)	Output Voltage	Output Power	Output Current	Input Current		Over Voltage Protection	Max. capacitive Load	Efficiency (typ.)
				Max.	@Max. Load	@No Load			@Max. Load
	VDC	VDC	W	A	mA(typ.)	mA(typ.)	VDC	µF	%
MRZI100-110S05	110 (36 ~ 160)	5	100	20	993.5	6	6.2	34000	91.5
MRZI100-110S12		12	100.8	8.4	1007	6	15	5830	91
MRZI100-110S15		15	100.5	6.7	1009	6	18	3670	90.5
MRZI100-110S24		24	100.8	4.2	1029	6	30	1460	89
MRZI100-110S54		54	99.9	1.85	1020	6	66	380	89

Input Specifications

Parameter	Min.	Typ.	Max.	Unit
Input Voltage Range (9)	36	110	160	VDC
Input Surge Voltage (100ms. max)	-0.7	---	170	
Start-up Threshold Voltage	---	---	36	
Under Voltage Shutdown	---	35	---	
Input Filter	Internal Capacitor			

Output Specifications

Parameter	Conditions			Min.	Typ.	Max.	Unit
Output Voltage Setting Accuracy				---	---	±1.0	%
Line Regulation	Vin=Min. to Max. @ Full Load			---	---	±0.2	%
Load Regulation	Min. Load to Full Load			---	---	±0.3	%
Min. Load	No minimum Load Requirement						
Ripple & Noise	0-20 MHz Bandwidth	5V Output	Measured with a 22µF/25V POLYMER	---	100	---	mV P-P
		12V, 15V Output		---	150	---	mV P-P
		24V Output	Measured with a 33µF/35V POLYMER	---	200	---	mV P-P
		54V Output	Measured with a 1µF/100V MLCC	---	300	---	mV P-P
Start Up Time (Power On)				---	50	---	ms
Transient Recovery Time	25% Load Step Change (2)			---	250	---	µsec
Transient Response Deviation				---	±3	±5	%
Temperature Coefficient				---	---	±0.02	%/°C
Trim Up / Down Range (8)	% of Nominal Output Voltage		Other Models	---	---	±10	%
			54V Output	---	---	+5 / -15	%
Over Load Protection (7)	Current Limitation at 150% typ. of Iout max., Hiccup						
Short Circuit Protection	Continuous, Automatic Recovery (Hiccup Mode 0.3Hz typ.)						

General Specifications

Parameter		Conditions	Min.	Typ.	Max.	Unit
I/O Isolation Voltage		Reinforced Insulation, Rated For 60 Seconds	2000	---	---	VAC
Isolation Voltage	Input to case	Rated For 60 Seconds	1500	---	---	VAC
	Output to case		500	---	---	VAC
I/O Isolation Resistance		500 VDC	10	---	---	GΩ
I/O Isolation Capacitance		100kHz, 1V	---	1500	---	pF
Switching Frequency		Other Models	---	214	---	kHz
		54V Output	---	173	---	kHz
MTBF(calculated)		MIL-HDBK-217F@25℃ Full Load, Ground Benign	605,102	---	---	Hours
Safety Standards		EN 50155, IEC 60571				
		UL/cUL 62368-1 recognition(UL certificate), IEC/EN 62368-1				

Remote On/Off Control

Parameter			Conditions	Min.	Typ.	Max.	Unit
Positive logic (Standard)		Converter On	3.5V ~ 12V or Open Circuit				
		Converter Off	0V ~ 1.2V or Short Circuit				
Negative logic (Option)		Converter On	0V ~ 1.2V or Short Circuit				
		Converter Off	3.5V ~ 12V or Open Circuit				
Positive logic	Control Input Current	Converter On	Vctrl = 5.0V	---	---	0.5	mA
		Converter Off	Vctrl = 0V	---	---	-0.5	mA
Negative logic	Control Input Current	Converter On	Vctrl = 0V	---	---	-0.5	mA
		Converter Off	Vctrl = 5.0V	---	---	0.5	mA
Control Common			Referenced to Negative Input				
Standby Input Current			Nominal Vin	---	3	---	mA

EMC Specifications

Parameter	Standards & Level			Performance
General	Compliance with EN 50121-3-2 Railway Applications			
EMI (5)	Conduction	EN 55032/11	With external components	Class A
	Radiation			
EMS (5)	EN 55024, EN 55035			
	ESD	Direct discharge	Indirect discharge HCP & VCP	A
		EN 61000-4-2 air ± 8kV, Contact ± 6kV	Contact ± 6kV	
	Radiated immunity	EN 61000-4-3 10V/m		A
	Fast transient	EN 61000-4-4 ±2kV		A
	Surge	EN 61000-4-5 ±1kV		A
	Conducted immunity	EN 61000-4-6 10Vrms		A
	PFMF	EN 61000-4-8 3A/M		A

Environmental Specifications

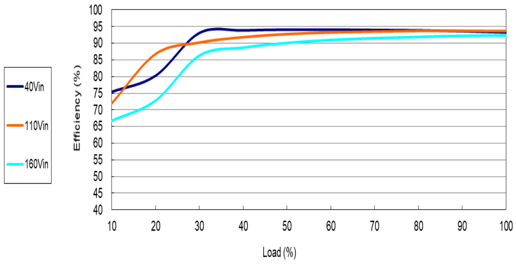
Parameter	Conditions	Min.	Typ.	Max.	Unit
Baseplate Temperature Range		-40	---	+105	℃
Over Temperature Protection (Baseplate)		---	+110	---	℃
Storage Temperature Range		-50	---	+125	℃
Cooling Test	Compliance to IEC/EN60068-2-1				
Dry Heat	Compliance to IEC/EN60068-2-2				
Damp Heat	Compliance to IEC/EN60068-2-30				
Vibration and Shock/Bump	Compliance to IEC/EN 61373				
Operating Humidity (non condensing)		5		95	% rel. H
Lead Temperature (1.5mm from case for 10Sec.)		---		260	℃

Notes

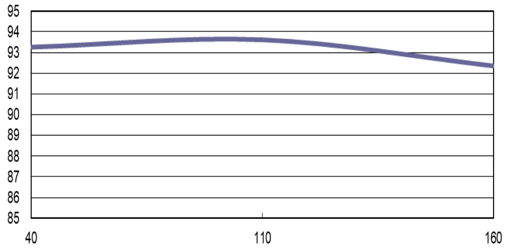
1. Specifications typical at Ta=+25℃, resistive load, nominal input voltage and rated output current unless otherwise noted.
2. Transient recovery time is measured to within 1% error band for a step change in output load of 75% to 100%.
3. Other input and output voltage may be available, please contact MINMAX.
4. It is necessary to parallel a capacitor across the input pins under normal operation. Minimum Capacitance: 150μF/ 250V KXJ.
5. The external components might be required to meet EMI/EMS standard for some of test items. Please contact MINMAX for the solution in detail.
6. The hot-swap operation is extremely prohibited.
7. Over Current Protection (OCP) is built in and works over 130% of the rated current or higher. However, use in an over current situation over 4 seconds must be avoided whenever possible.
8. Do not exceed maximum power specification when adjusting output voltage. Please see the External Output Trimming table at page 6.
9. *Input Voltage Vin= 36VDC/1s for Start-up Operation and Vin= 40VDC for Continuos Operation
10. Specifications are subject to change without notice.

Characteristic Curves

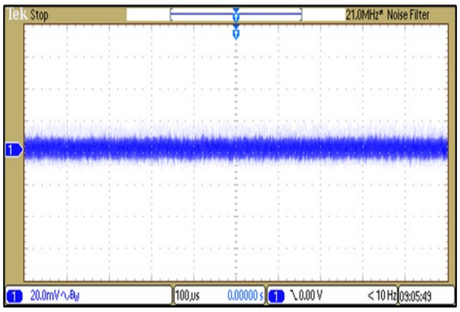
All test conditions are at 25℃ The figures are identical for MRZI100-110S05



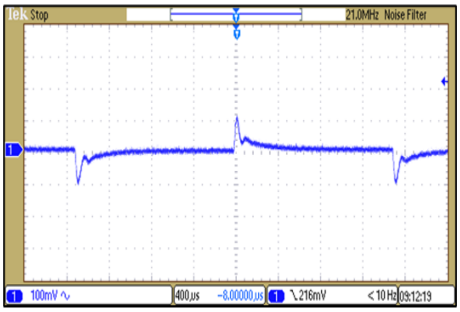
Efficiency Versus Output Current



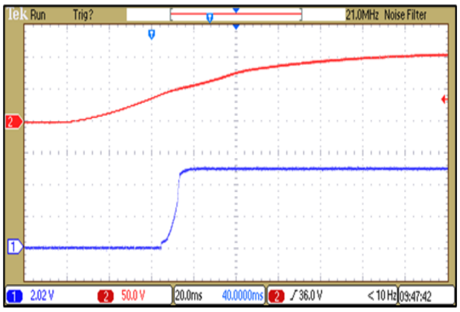
Efficiency Versus Input Voltage
Full Load



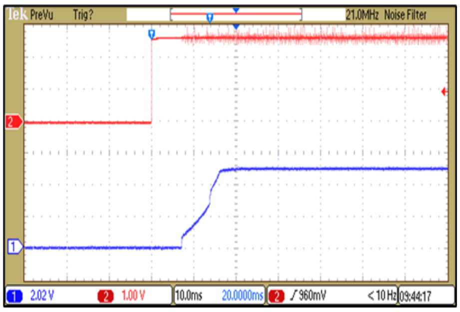
Typical Output Ripple and Noise
V_{in}=$V_{in\ nom}$; Full Load



Transient Response to Dynamic Load Change
from 100% to 75% of Full Load ; V_{in}=$V_{in\ nom}$



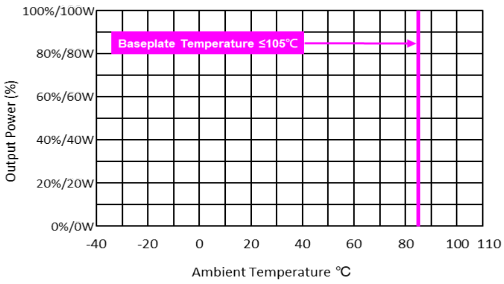
Typical Input Start-Up and Output Rise Characteristic
V_{in} =$V_{in\ nom}$; Full Load



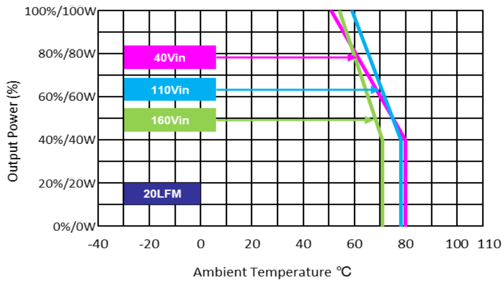
ON/OFF Voltage Start-Up and Output Rise Characteristic
V_{in} =$V_{in\ nom}$; Full Load

Characteristic Curves

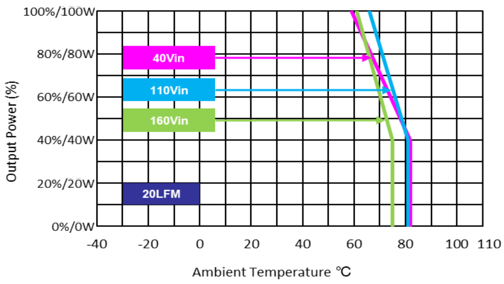
All test conditions are at 25℃ The figures are identical for MRZI100-110S05 (continued)



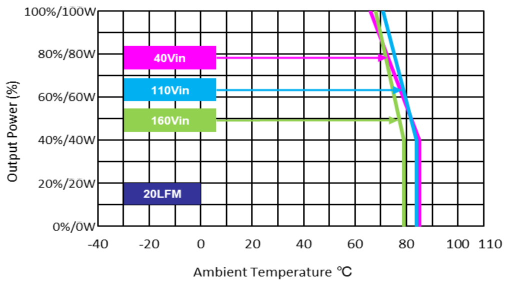
Derating Output Power Versus Ambient Temperature $V_{in}=V_{in\ nom}$



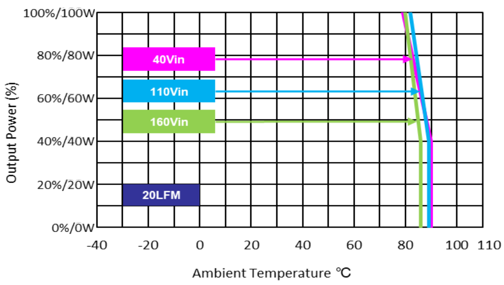
Derating Output Power Versus Ambient Temperature
(with HS5 heatsink)



Derating Output Power Versus Ambient Temperature
(with HS6 heatsink)



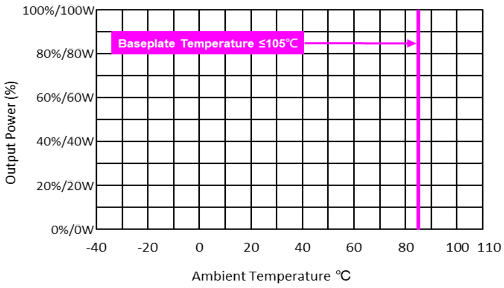
Derating Output Power Versus Ambient Temperature
(with HS7 heatsink)



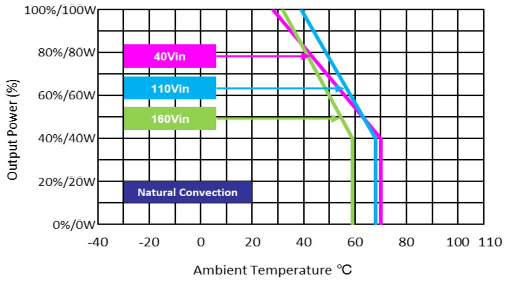
Derating Output Power Versus Ambient Temperature
(with 2U iron back-plate (Dimension 241X89X1.6mm))

Characteristic Curves

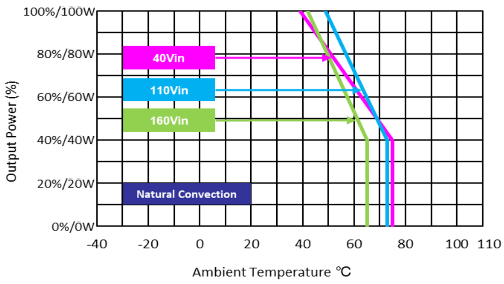
All test conditions are at 25℃ The figures are identical for MRZI100-110S05 (continued)



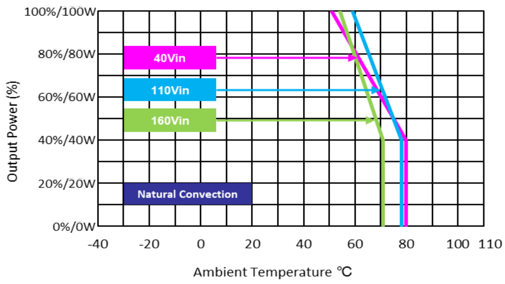
Derating Output Power Versus Ambient Temperature $V_{in}=V_{in\ nom}$



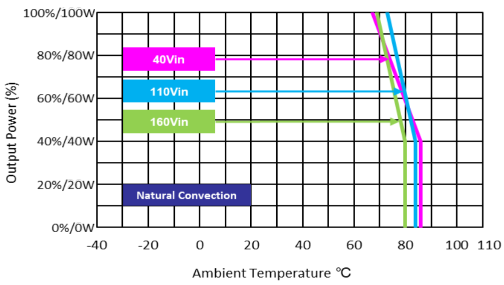
Derating Output Power Versus Ambient Temperature (with HS5 heatsink)



Derating Output Power Versus Ambient Temperature (with HS6 heatsink)



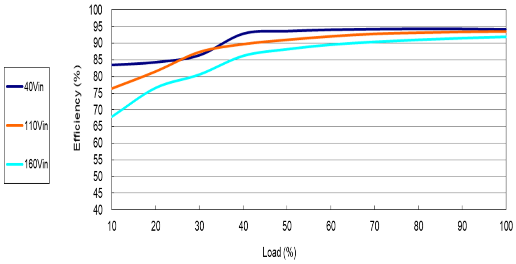
Derating Output Power Versus Ambient Temperature (with HS7 heatsink)



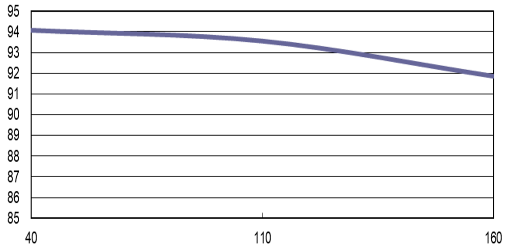
Derating Output Power Versus Ambient Temperature (with 2U iron back-plate (Dimension 241X89X1.6mm))

Characteristic Curves

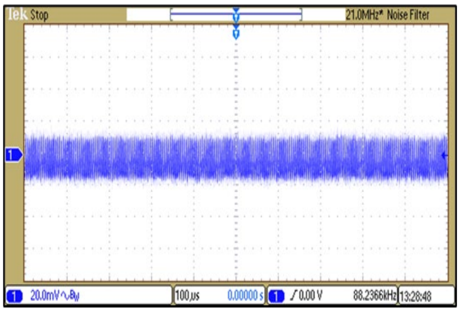
All test conditions are at 25℃ The figures are identical for MRZI100-110S12



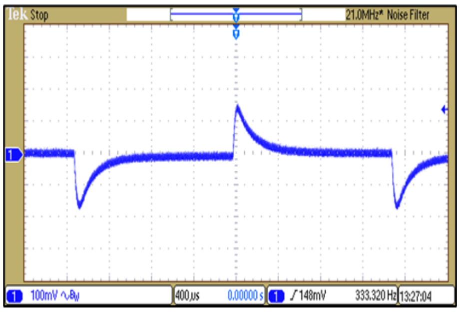
Efficiency Versus Output Current



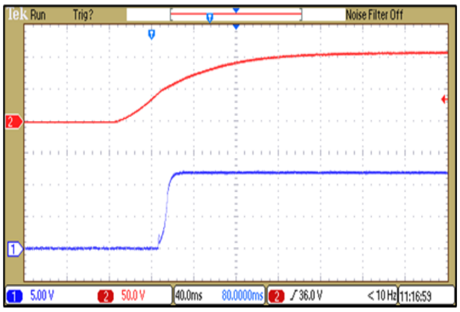
Efficiency Versus Input Voltage
Full Load



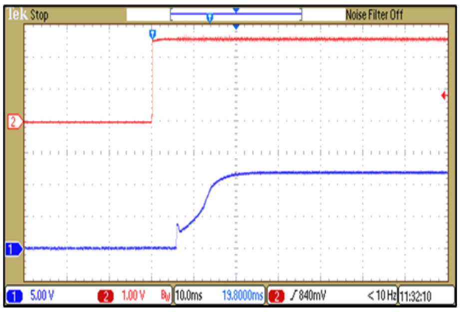
Typical Output Ripple and Noise
V_{in}=$V_{in\ nom}$; Full Load



Transient Response to Dynamic Load Change
from 100% to 75% of Full Load ; V_{in}=$V_{in\ nom}$



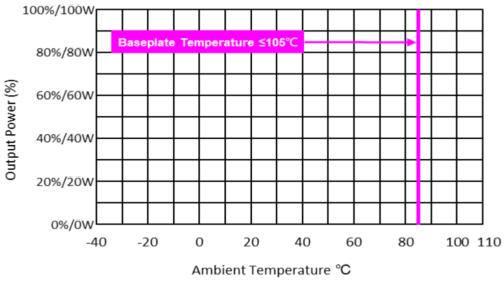
Typical Input Start-Up and Output Rise Characteristic
$V_{in=}$ =$V_{in\ nom}$; Full Load



ON/OFF Voltage Start-Up and Output Rise Characteristic
$V_{in=}$ =$V_{in\ nom}$; Full Load

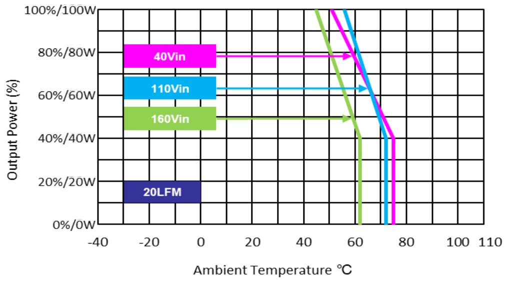
Characteristic Curves

All test conditions are at 25℃ The figures are identical for MRZI100-110S12 (continued)



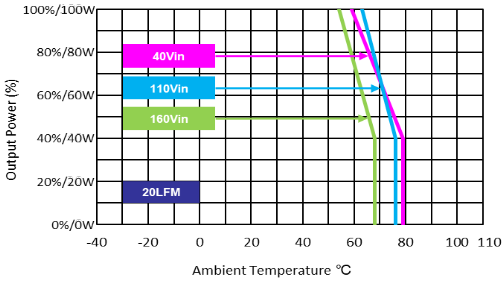
Derating Output Power Versus Ambient Temperature and Airflow

$V_{in}=V_{in\ nom}$



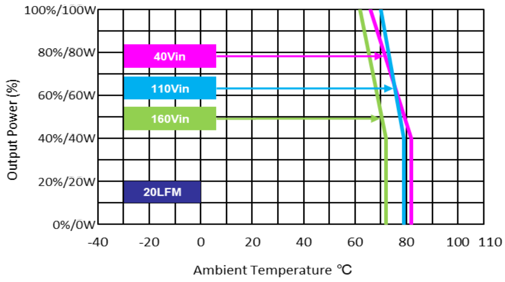
Derating Output Power Versus Ambient Temperature

(with HS5 heatsink)



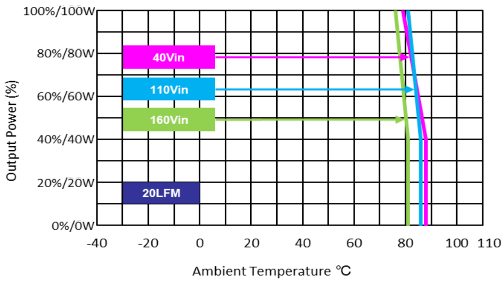
Derating Output Power Versus Ambient Temperature

(with HS6 heatsink)



Derating Output Power Versus Ambient Temperature

(with HS7 heatsink)

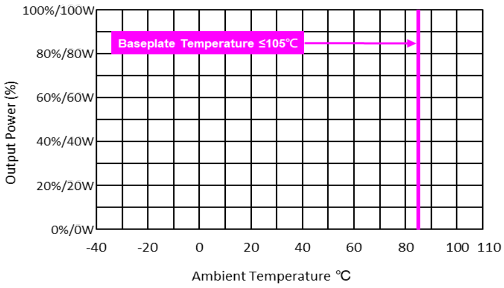


Derating Output Power Versus Ambient Temperature

(with 2U iron back-plate (Dimension 241X89X1.6mm))

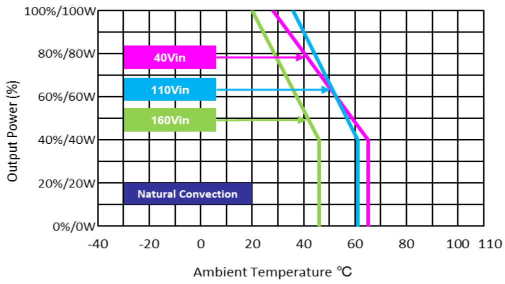
Characteristic Curves

All test conditions are at 25℃ The figures are identical for MRZI100-110S12 (continued)



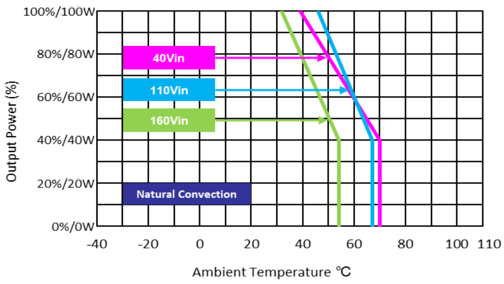
Derating Output Power Versus Ambient Temperature and Airflow

V_{in}=$V_{in\ nom}$



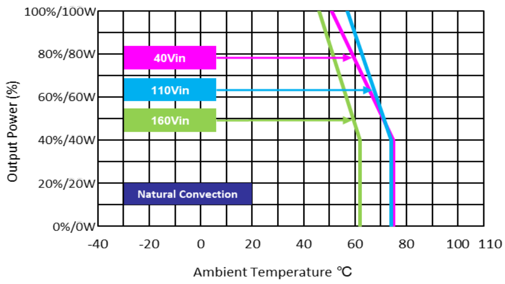
Derating Output Power Versus Ambient Temperature

(with HS5 heatsink)



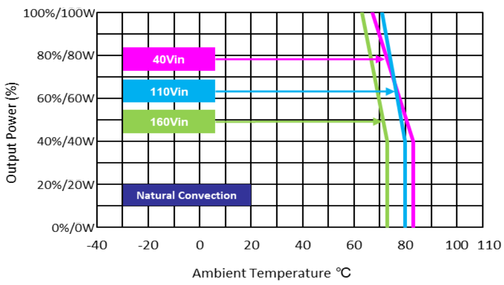
Derating Output Power Versus Ambient Temperature

(with HS6 heatsink)



Derating Output Power Versus Ambient Temperature

(with HS7 heatsink)

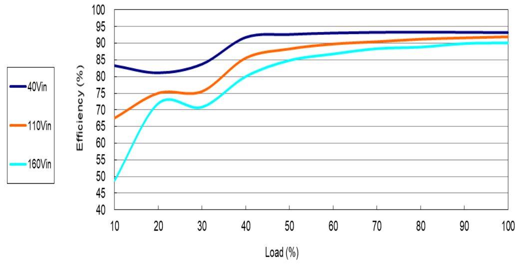


Derating Output Power Versus Ambient Temperature

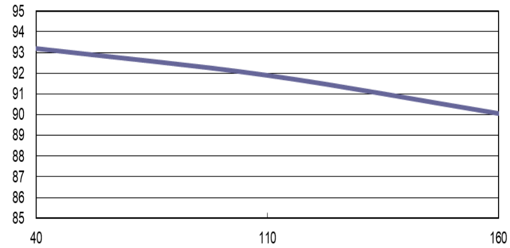
(with 2U iron back-plate (Dimension 241X89X1.6mm))

Characteristic Curves

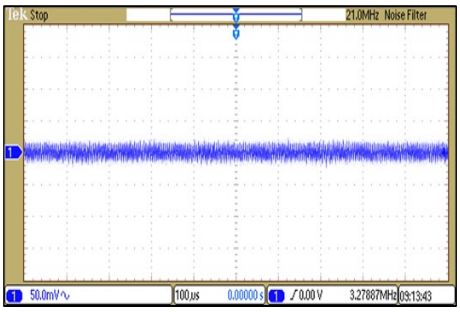
All test conditions are at 25℃ The figures are identical for MRZI100-110S15



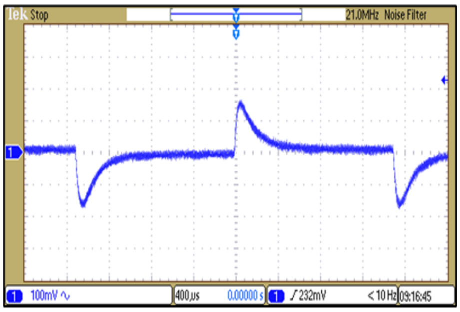
Efficiency Versus Output Current



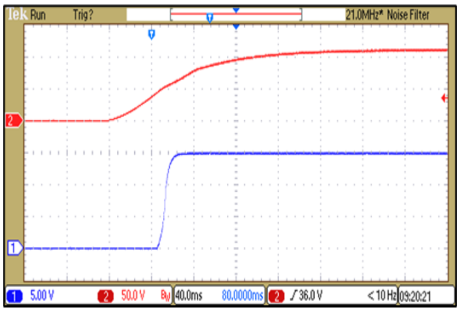
Efficiency Versus Input Voltage
Full Load



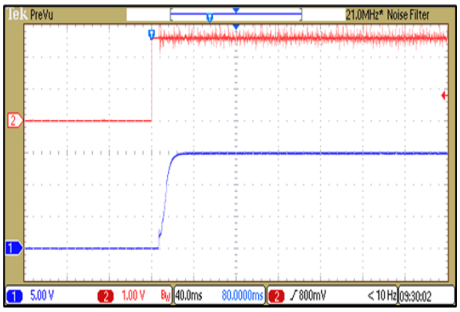
Typical Output Ripple and Noise
V_{in}=$V_{in\ nom}$; Full Load



Transient Response to Dynamic Load Change
from 100% to 75% of Full Load ; V_{in}=$V_{in\ nom}$



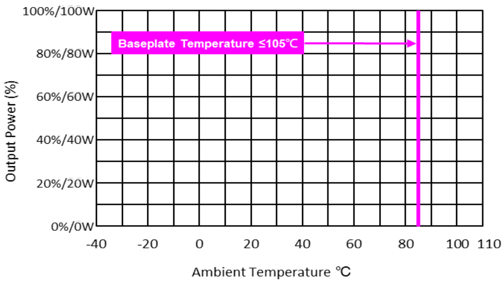
Typical Input Start-Up and Output Rise Characteristic
$V_{in=}$ =$V_{in\ nom}$; Full Load



ON/OFF Voltage Start-Up and Output Rise Characteristic
$V_{in=}$ =$V_{in\ nom}$; Full Load

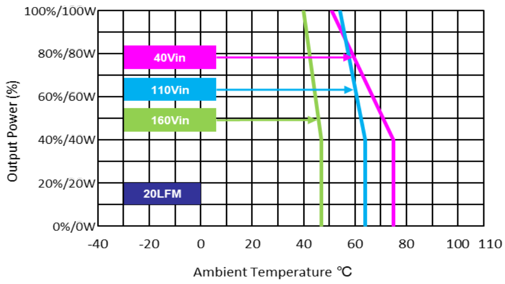
Characteristic Curves

All test conditions are at 25℃ The figures are identical for MRZI100-110S15 (continued)



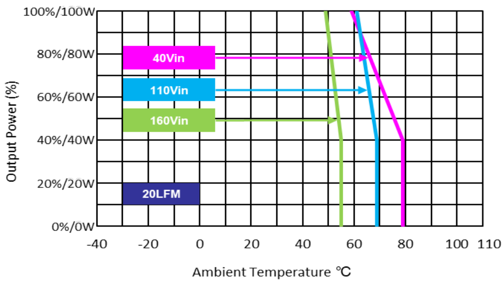
Derating Output Power Versus Ambient Temperature and Airflow

$V_{in}=V_{in\ nom}$



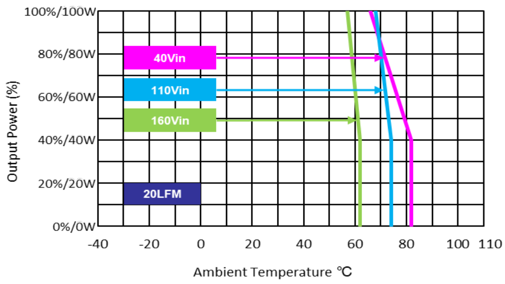
Derating Output Power Versus Ambient Temperature

(with HS5 heatsink)



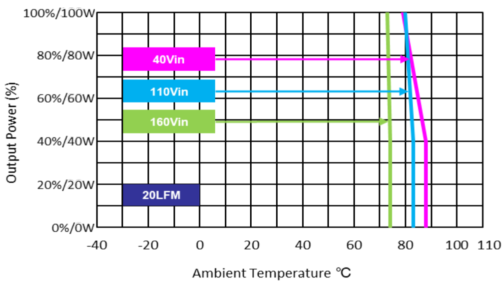
Derating Output Power Versus Ambient Temperature

(with HS6 heatsink)



Derating Output Power Versus Ambient Temperature

(with HS7 heatsink)

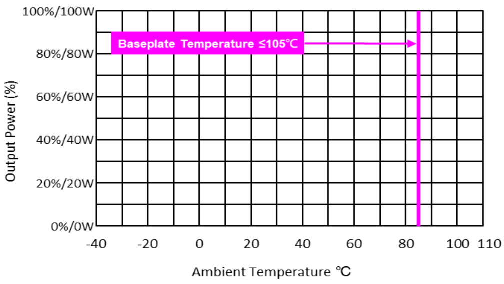


Derating Output Power Versus Ambient Temperature

(with 2U iron back-plate (Dimension 241X89X1.6mm))

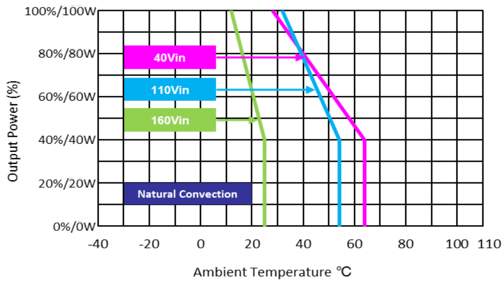
Characteristic Curves

All test conditions are at 25℃ The figures are identical for MRZI100-110S15 (continued)



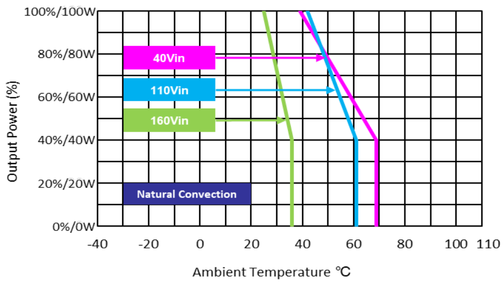
Derating Output Power Versus Ambient Temperature and Airflow

$V_{in}=V_{in\ nom}$



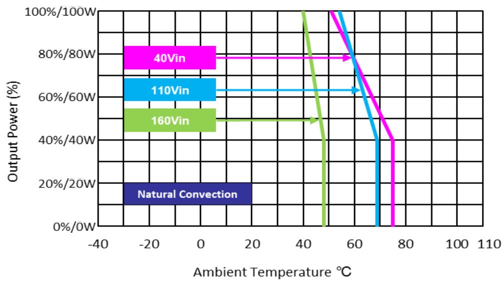
Derating Output Power Versus Ambient Temperature

(with HS5 heatsink)



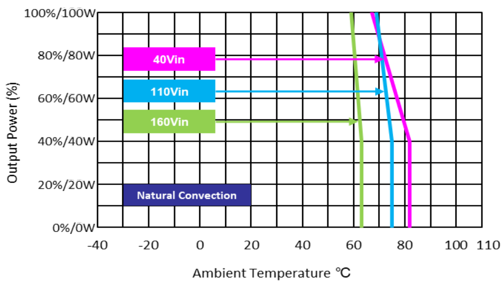
Derating Output Power Versus Ambient Temperature

(with HS6 heatsink)



Derating Output Power Versus Ambient Temperature

(with HS7 heatsink)

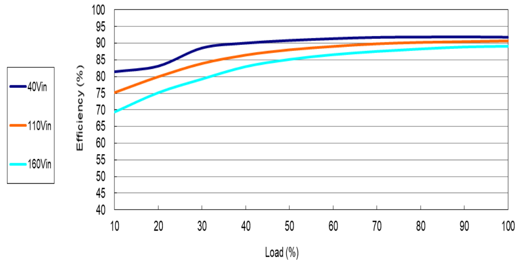


Derating Output Power Versus Ambient Temperature

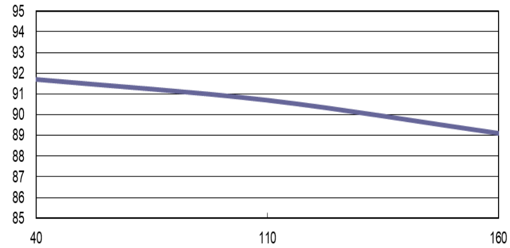
(with 2U iron back-plate (Dimension 241X89X1.6mm))

Characteristic Curves

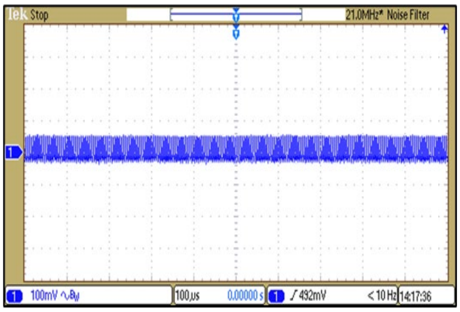
All test conditions are at 25℃ The figures are identical for MRZI100-110S24



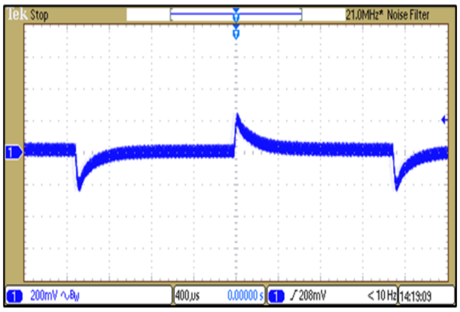
Efficiency Versus Output Current



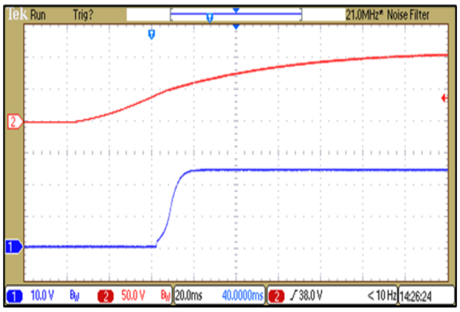
Efficiency Versus Input Voltage
Full Load



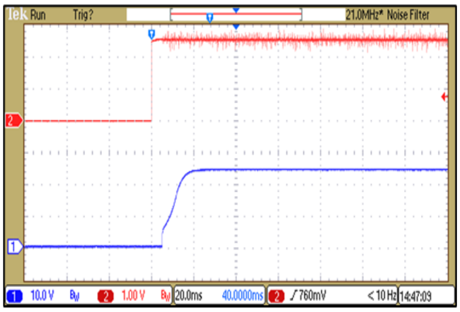
Typical Output Ripple and Noise
V_{in}=$V_{in\ nom}$; Full Load



Transient Response to Dynamic Load Change
from 100% to 75% of Full Load ; V_{in}=$V_{in\ nom}$



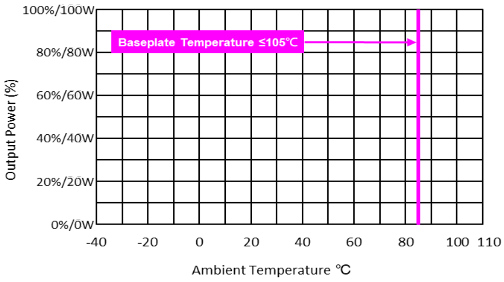
Typical Input Start-Up and Output Rise Characteristic
$V_{in=}$ =$V_{in\ nom}$; Full Load



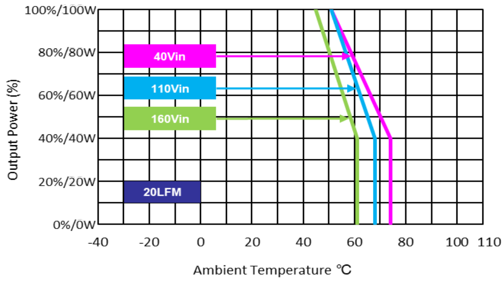
ON/OFF Voltage Start-Up and Output Rise Characteristic
$V_{in=}$ =$V_{in\ nom}$; Full Load

Characteristic Curves

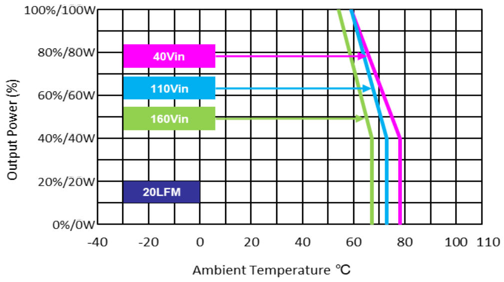
All test conditions are at 25℃ The figures are identical for MRZI100-110S24 (continued)



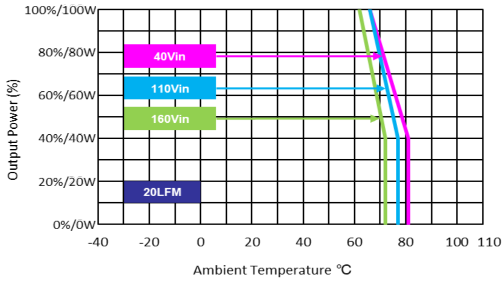
Derating Output Power Versus Ambient Temperature and Airflow
$V_{in}=V_{in\ nom}$



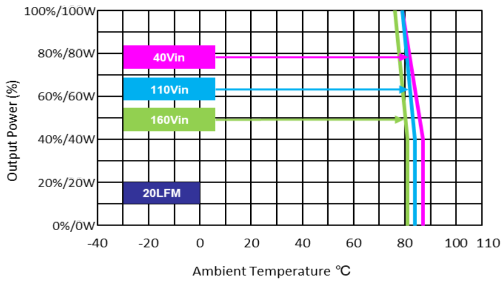
Derating Output Power Versus Ambient Temperature
(with HS5 heatsink)



Derating Output Power Versus Ambient Temperature
(with HS6 heatsink)



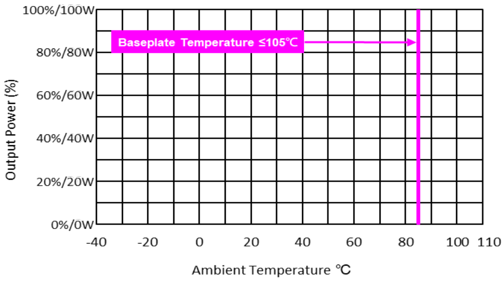
Derating Output Power Versus Ambient Temperature
(with HS7 heatsink)



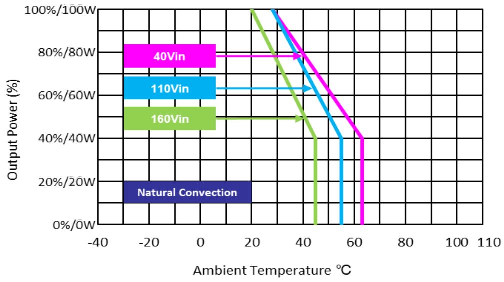
Derating Output Power Versus Ambient Temperature
(with 2U iron back-plate (Dimension 241X89X1.6mm))

Characteristic Curves

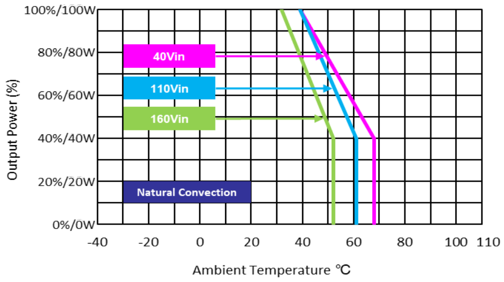
All test conditions are at 25℃ The figures are identical for MRZI100-110S24 (continued)



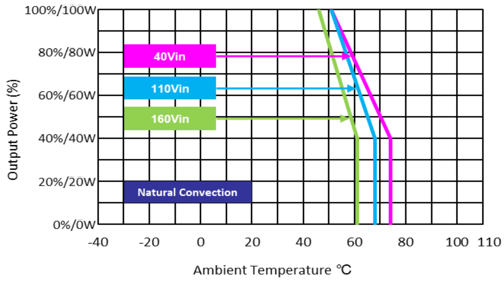
Derating Output Power Versus Ambient Temperature and Airflow
$V_{in}=V_{in\ nom}$



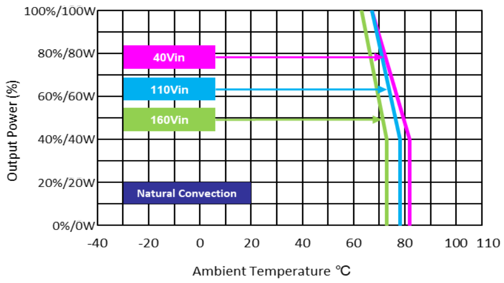
Derating Output Power Versus Ambient Temperature
(with HS5 heatsink)



Derating Output Power Versus Ambient Temperature
(with HS6 heatsink)



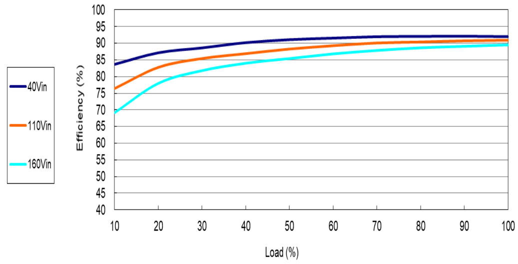
Derating Output Power Versus Ambient Temperature
(with HS7 heatsink)



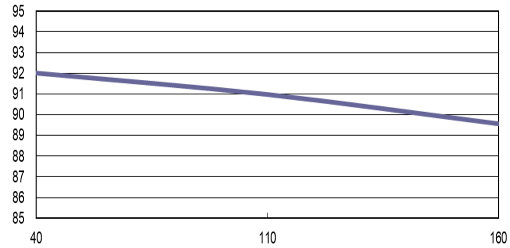
Derating Output Power Versus Ambient Temperature
(with 2U iron back-plate (Dimension 241X89X1.6mm))

Characteristic Curves

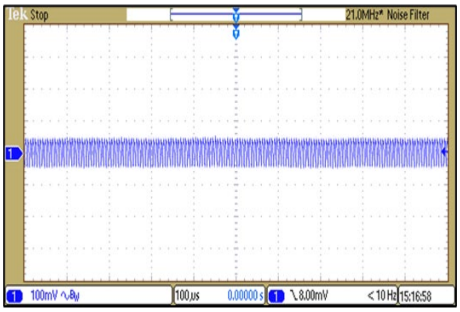
All test conditions are at 25℃ The figures are identical for MRZI100-110S54



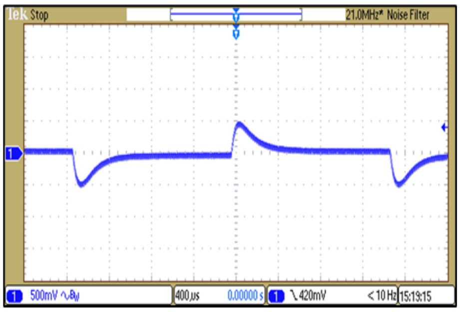
Efficiency Versus Output Current



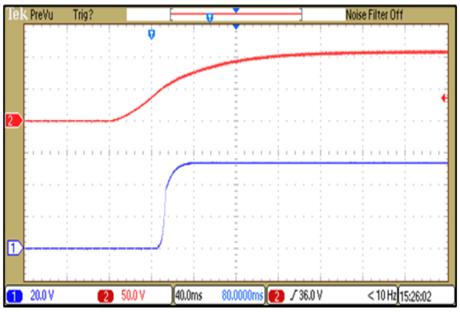
Efficiency Versus Input Voltage
Full Load



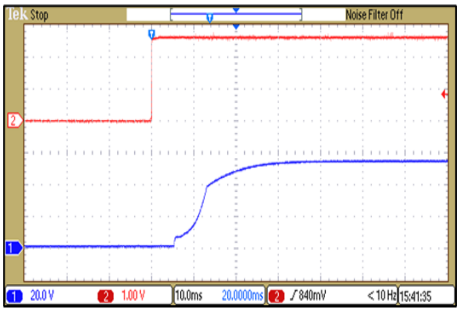
Typical Output Ripple and Noise
$V_{in}=V_{in\ nom}$; Full Load



Transient Response to Dynamic Load Change
from 100% to 75% of Full Load ; $V_{in}=V_{in\ nom}$



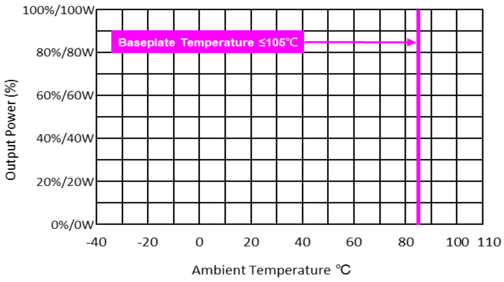
Typical Input Start-Up and Output Rise Characteristic
$V_{in}=V_{in\ nom}$; Full Load



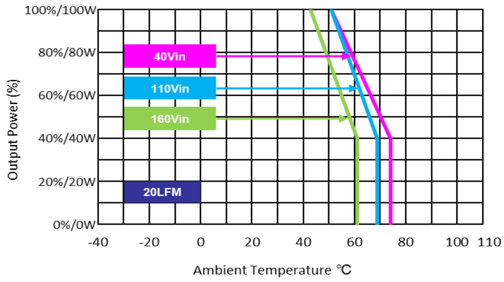
ON/OFF Voltage Start-Up and Output Rise Characteristic
$V_{in}=V_{in\ nom}$; Full Load

Characteristic Curves

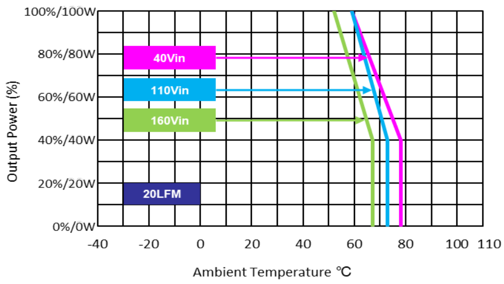
All test conditions are at 25℃ The figures are identical for MRZI100-110S54 (continued)



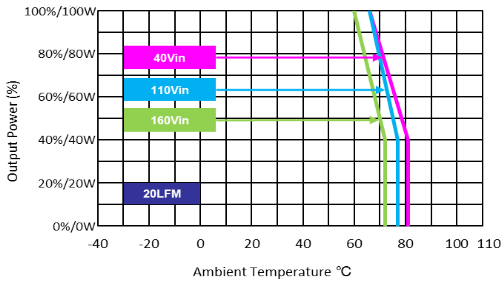
Derating Output Power Versus Ambient Temperature and Airflow
$V_{in}=V_{in\ nom}$



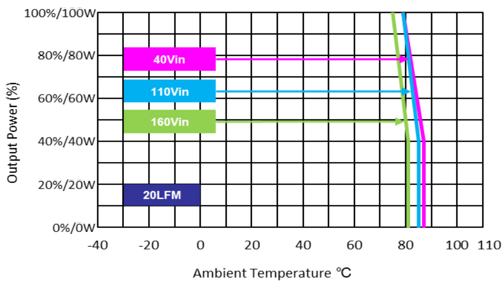
Derating Output Power Versus Ambient Temperature
(with HS5 heatsink)



Derating Output Power Versus Ambient Temperature
(with HS6 heatsink)



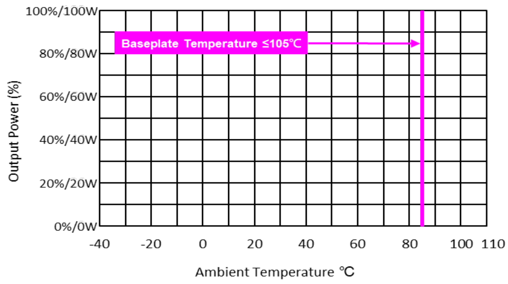
Derating Output Power Versus Ambient Temperature
(with HS7 heatsink)



Derating Output Power Versus Ambient Temperature
(with 2U iron back-plate (Dimension 241X89X1.6mm))

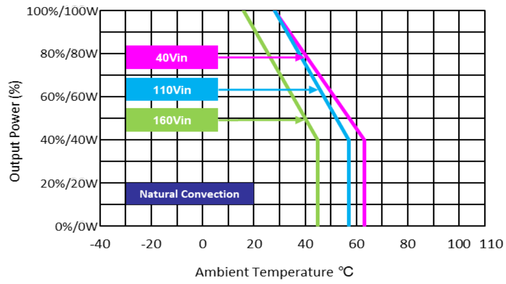
Characteristic Curves

All test conditions are at 25℃ The figures are identical for MRZI100-110S54 (continued)



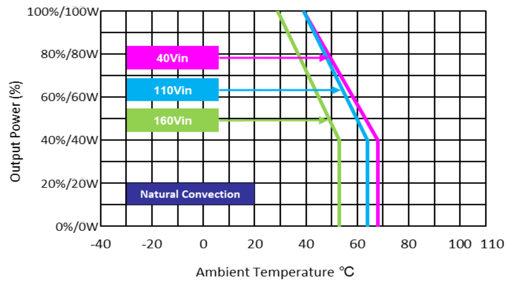
Derating Output Power Versus Ambient Temperature and Airflow

$V_{in}=V_{in\ nom}$



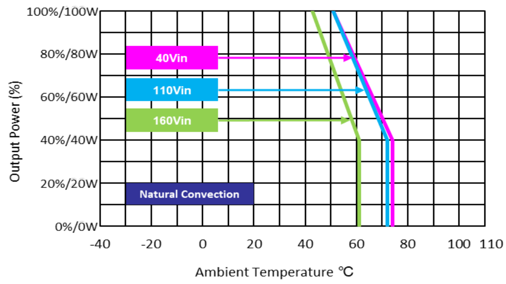
Derating Output Power Versus Ambient Temperature

(with HS5 heatsink)



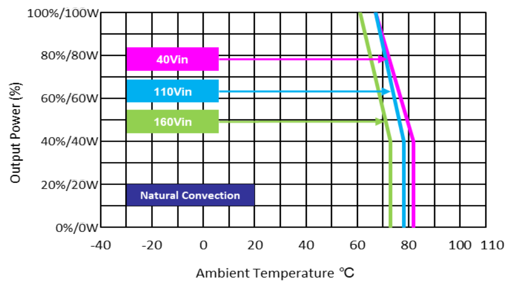
Derating Output Power Versus Ambient Temperature

(with HS6 heatsink)



Derating Output Power Versus Ambient Temperature

(with HS7 heatsink)

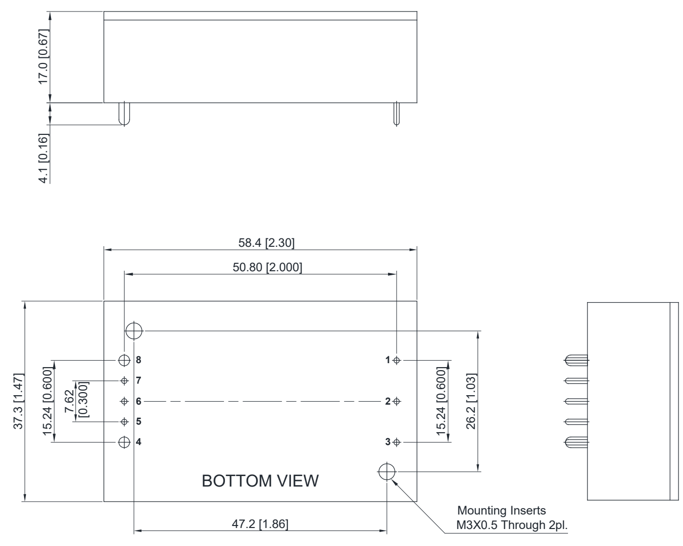


Derating Output Power Versus Ambient Temperature

(with 2U iron back-plate (Dimension 241X89X1.6mm))

Package Specifications

Mechanical Dimensions



Pin Connections

Pin	Function	Diameter mm (inches)
1	+Vin	Ø 1.0 [0.04]
2	Remote On/Off	Ø 1.0 [0.04]
3	-Vin	Ø 1.0 [0.04]
4	-Vout	Ø 2.0 [0.08]
5	* -Sense	Ø 1.0 [0.04]
6	Trim	Ø 1.0 [0.04]
7	* +Sense	Ø 1.0 [0.04]
8	+Vout	Ø 2.0 [0.08]

* If remote sense not used the +sense should be connected to +output and –sense should be connected to –output
Maximum output deviation is 10% inclusive of trim

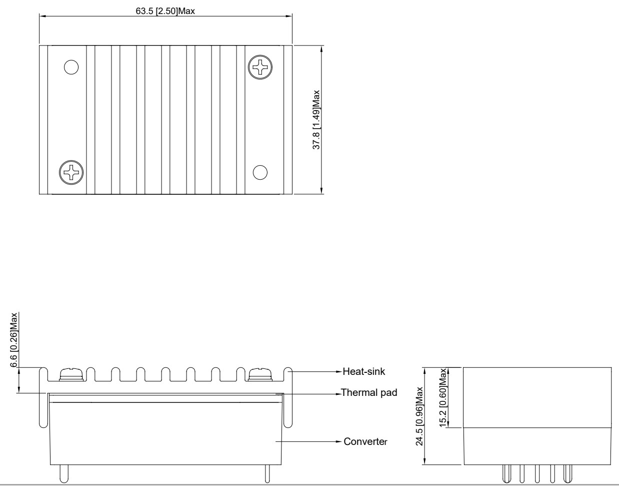
- All dimensions in mm (inches)
- Tolerance: X.X±0.5 (X.XX±0.02)
  X.XX±0.25 (X.XXX±0.01)
- Pin diameter tolerance: X.X±0.05 (X.XX±0.002)

Physical Characteristics

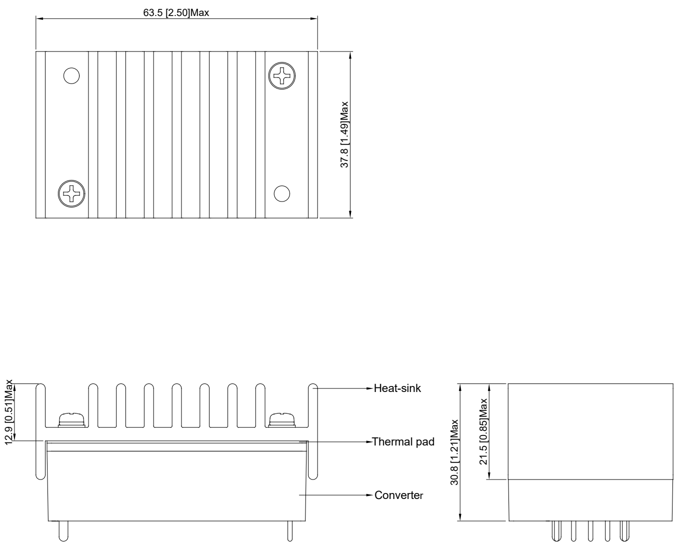
Case Size	:	58.4x37.3x17.0 mm (2.30x1.47x0.67 inches)
Case Material	:	Plastic resin (flammability to UL 94V-0 rated)
Top Side Base Material	:	Aluminum Plate
Pin Material	:	Copper
Potting Material	:	Silicone (UL94-V0)
Weight	:	107g

Heatsink

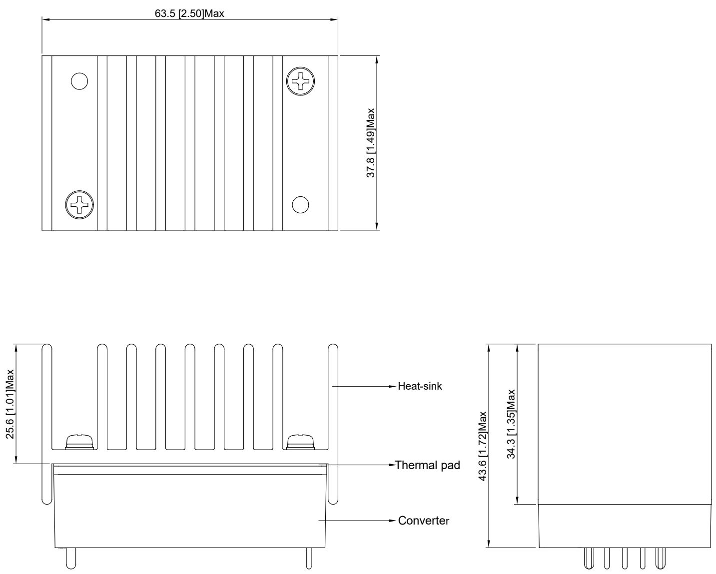
Option–HS5



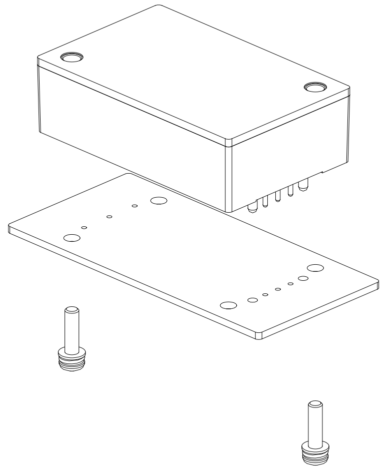
Option–HS6

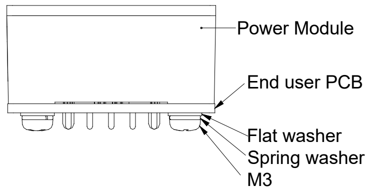


Option–HS7



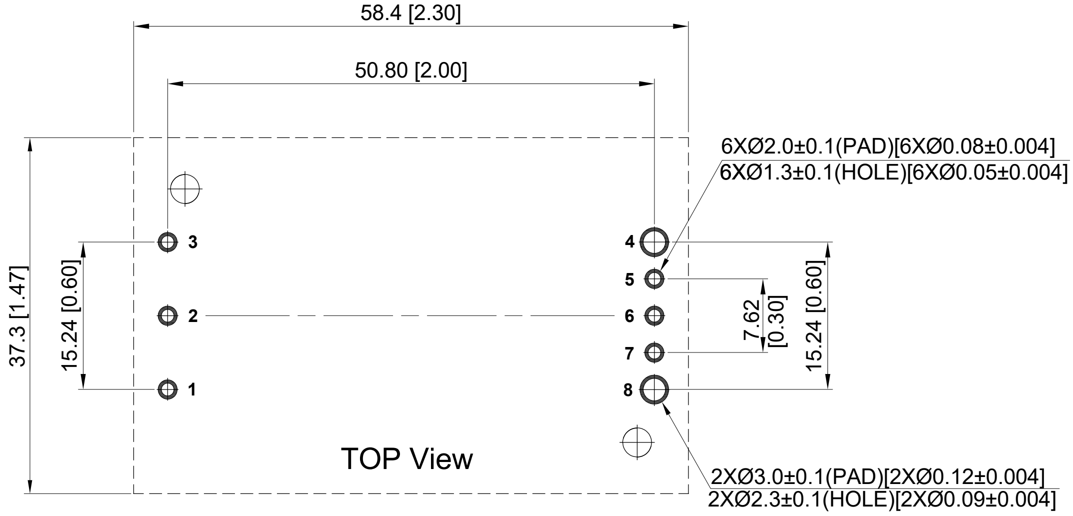
PCB Installation of End Users





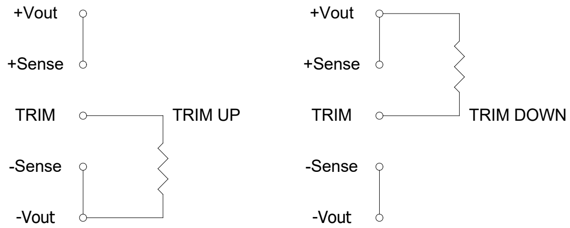
1. Please evaluates mechanical stress (vibration, shock, bump) during field applications.
2. It has to equip with installation kit if escess the guaranteed specifications, please contacts MINMAX for detail information.
3. Applied torque per screw 9 kgf.cm min.

Recommended Pad Layout



External Output Trimming

Output can be externally trimmed by using the method shown below

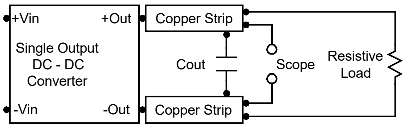


	MRZI100-110S05		MRZI100-110S12		MRZI100-110S15		MRZI100-110S24		MRZI100-110S54	
Trim Range (%)	Trim down (kΩ)	Trim up (kΩ)	Trim down (kΩ)	Trim up (kΩ)	Trim down (kΩ)	Trim up (kΩ)	Trim down (kΩ)	Trim up (kΩ)	Trim down (kΩ)	Trim up (kΩ)
1	138.88	106.87	413.55	351.00	530.73	422.77	598.66	487.14	1,882.57	560.73
2	62.41	47.76	184.55	157.50	238.61	189.89	267.78	218.02	877.94	230.36
3	36.92	28.06	108.22	93.00	141.24	112.26	157.49	128.31	543.06	120.24
4	24.18	18.21	70.05	60.75	92.56	73.44	102.34	83.46	375.62	65.18
5	16.53	12.30	47.15	41.40	63.35	50.15	69.25	56.55	275.15	32.15
6	11.44	8.36	31.88	28.50	43.87	34.63	47.19	38.61	208.18	---
7	7.79	5.55	20.98	19.29	29.96	23.54	31.44	25.79	160.34	---
8	5.06	3.44	12.80	12.37	19.53	15.22	19.62	16.18	124.46	---
9	2.94	1.79	6.44	7.00	11.41	8.75	10.43	8.70	96.55	---
10	1.24	0.48	1.35	2.70	4.92	3.58	3.08	2.72	74.23	---
11	---	---	---	---	---	---	---	---	55.96	---
12	---	---	---	---	---	---	---	---	40.74	---
13	---	---	---	---	---	---	---	---	27.86	---
14	---	---	---	---	---	---	---	---	16.82	---
15	---	---	---	---	---	---	---	---	7.25	---

Test Setup

Peak-to-Peak Output Noise Measurement Test

Use a 22μF polymer capacitor for 5V, 12V, 15V output models and a 33μF polymer capacitor for 24V output model and a 1μF ceramic capacitor for 54V output model. Scope measurement should be made by using a BNC socket, measurement bandwidth is 0-20 MHz. Position the load between 50 mm and 75 mm from the DC-DC Converter.



Technical Notes

Remote On/Off

Positive logic remote on/off turns the module on during a logic high voltage on the remote on/off pin, and off during a logic low. To turn the power module on and off, the user must supply a switch to control the voltage between the on/off terminal and the -Vin terminal. The switch can be an open collector or equivalent. A logic low is 0V to 1.2V. A logic high is 3.5V to 12V. The maximum sink current at the on/off terminal (Pin 2) during a logic low is -500μA.
Negative logic remote on/off turns the module on during a logic low voltage on the remote on/off pin, and off during a logic high. To turn the power module on and off, the user must supply a switch to control the voltage between the on/off terminal and the -Vin terminal. The switch can be an open collector or equivalent. A logic low is 0V to 1.2V. A logic high is 3.5V to 12V. The maximum source current at the on/off terminal (Pin 2) during a logic high is 500**μ**A.

Overload Protection

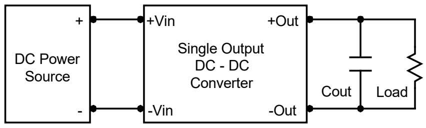
To provide hiccup mode protection in a fault (output overload) condition, the unit is equipped with internal current limiting circuitry and can endure overload for an unlimited duration.

Overvoltage Protection

The output overvoltage clamp consists of control circuitry, which is independent of the primary regulation loop, that monitors the voltage on the output terminals. The control loop of the clamp has a higher voltage set point than the primary loop. This provides a redundant voltage control that reduces the risk of output overvoltage. The OVP level can be found in the output data.

Output Ripple Reduction

A good quality low ESR capacitor placed as close as practicable across the load will give the best ripple and noise performance. To reduce output ripple, it is recommended to use 4.7μF capacitors at the output.

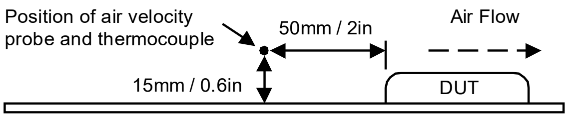


Maximum Capacitive Load

The MRZI100 series has limitation of maximum connected capacitance at the output. The power module may be operated in current limiting mode during start-up, affecting the ramp-up and the startup time. The maximum capacitance can be found in the data sheet.

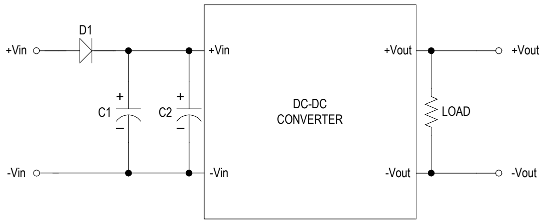
Thermal Considerations

Many conditions affect the thermal performance of the power module, such as orientation, airflow over the module and board spacing. To avoid exceeding the maximum temperature rating of the components inside the power module, the baseplate temperature must be kept below 105°C. The derating curves are determined from measurements obtained in a test setup.



Railway EN 50155 Certified

External Filter meets Power Supply Test for EN 50155 DIP & INTERRUPTION

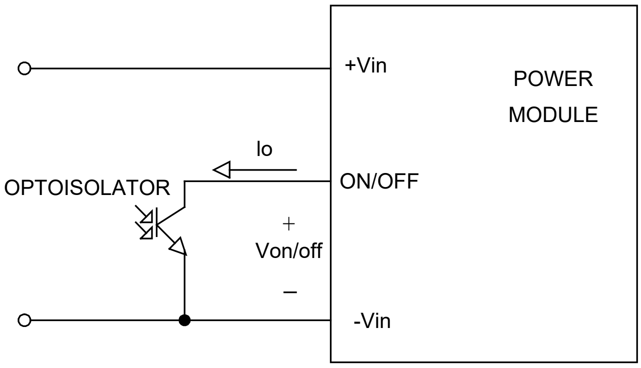


Model	D1	C1, C2
MRZI100 Series	IN5408	470μF/200V CHEMI-CON KXJ Series

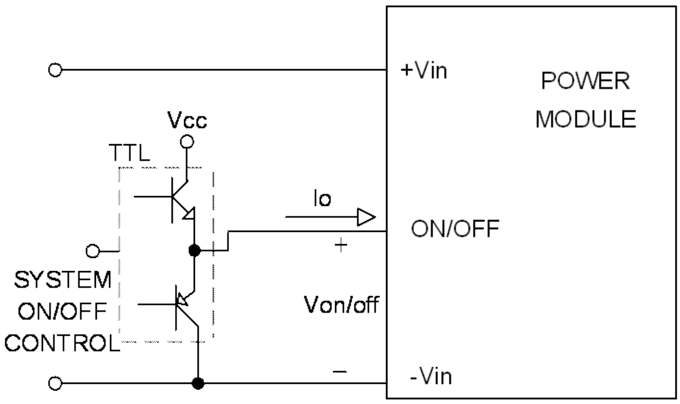
Remote On/Off Implementation

The positive logic remote ON/OFF control circuit is included. Turns the module ON during logic High on the ON/Off pin and turns OFF during logic Low. The ON/OFF input signal (Von/off) that referenced to GND. If not using the remote on/off feature, please open circuit between on/off pin and -Vin pin to turn the module on.

The negative logic remote ON/OFF control circuit is included. Turns the module ON during logic Low on the ON/Off pin and turns OFF during logic High. The ON/OFF input signal (Von/off) that referenced to GND. If not using the remote on/off feature, please short circuit between on/off pin and -Vin pin to turn the module on.

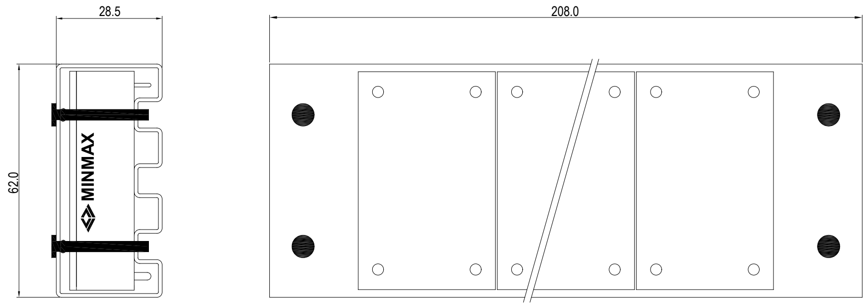


Isolated-Closure Remote ON/OFF

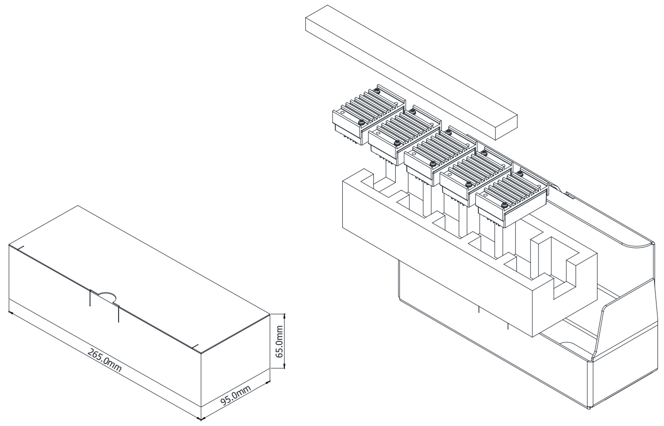


Level Control Using TTL Output

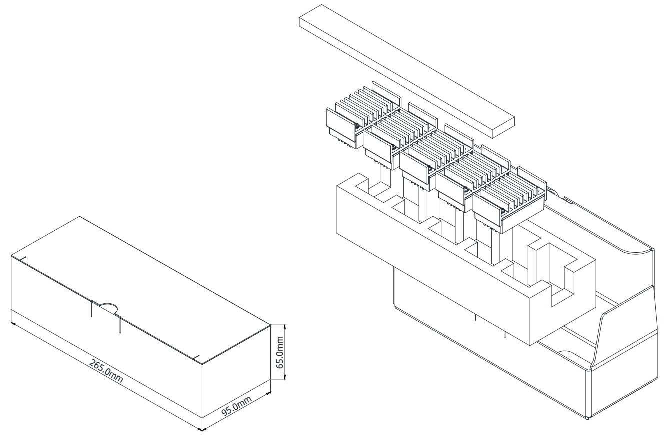
Packaging Information



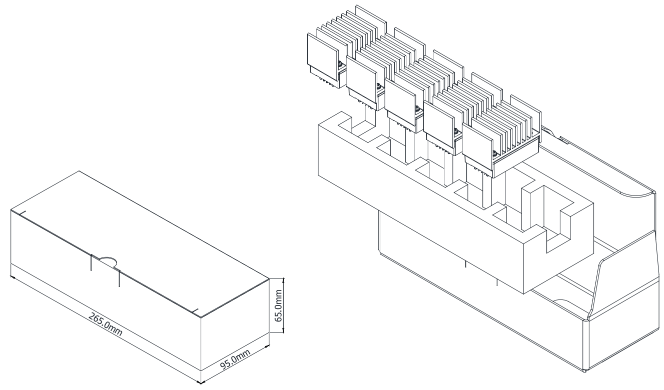
Unit: mm
5 PCS per TUBE (Without heatsink)



MRZI100-HS5 5 PCS per Box (With heatsink)



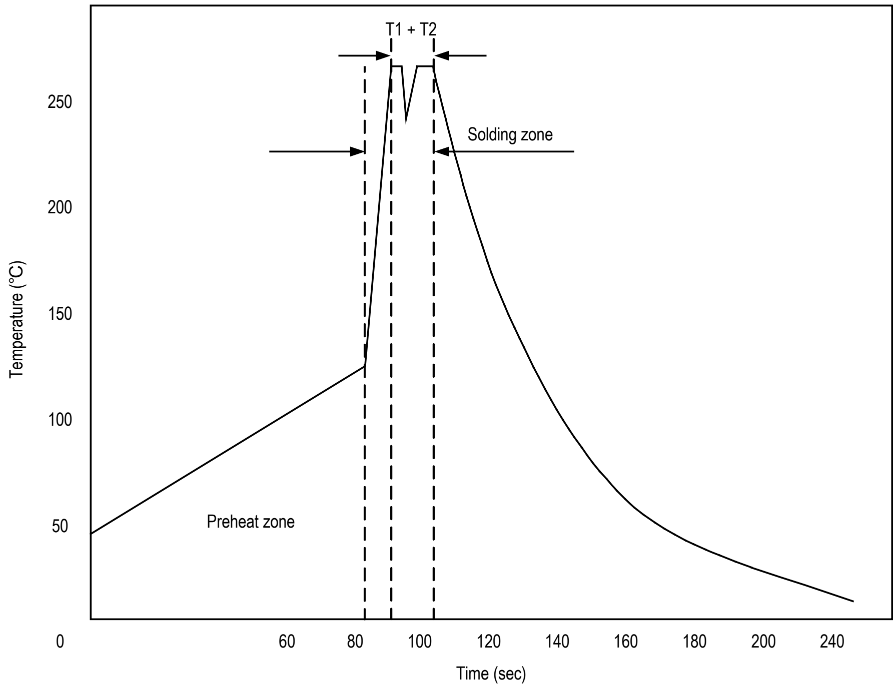
MRZI100-HS6 5 PCS per Box (With heatsink)



MRZI100-HS7 5 PCS per Box (With heatsink)

Wave Soldering Considerations

Lead free wave solder profile



Zone	Reference Parameter
Preheat	Rise temp. speed：3°C/sec max.
zone	Preheat temp.：100~130°C
Actual	Peak temp.：250~260°C
heating	Peak time(T1+T2)：4~6 sec

Hand Welding Parameter

Reference Solder: Sn-Ag-Cu：Sn-Cu：Sn-Ag

Hand Welding: Soldering iron：Power 60W

Welding Time: 2~4 sec

Temp.: 380~400°C

Part Number Structure

M	R	ZI	100	-	110	S	05
	Application Railway	Ultra-wide 4:1 Input Voltage Range	Output Power 100 Watt		Input Voltage Range 110: 36 ~ 160 VDC	Output Quantity S: Single	Output Voltage 05: 5 VDC 12: 12 VDC 15: 15 VDC 24: 24 VDC 54: 54 VDC

MTBF and Reliability

The MTBF of MRZI100 series of DC-DC converters has been calculated using

MIL-HDBK 217F NOTICE2, Operating Temperature 25℃, Ground Benign.

Model	MTBF	Unit
MRZI100-110S05	605,102	Hours
MRZI100-110S12	721,451	
MRZI100-110S15	646,084	
MRZI100-110S24	692,939	
MRZI100-110S54	773,597	